1200V 60A APT60D120B APT60D120S APT60D120BG\* APT60D120SG\*

\*G Denotes RoHS Compliant, Pb Free Terminal Finish.

# **ULTRAFAST SOFT RECOVERY RECTIFIER DIODE**

## **PRODUCT APPLICATIONS**

- Anti-Parallel Diode

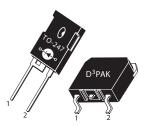
   Switchmode Power Supply
   Inverters
- Free Wheeling Diode
   -Motor Controllers
   -Converters
   -Inverters
- Snubber Diode
- PFC

# **PRODUCT FEATURES**

- Ultrafast Recovery Times
- Soft Recovery Characteristics
- Popular TO-247 Package or Surface Mount D³PAK Package
- Low Forward Voltage
- Low Leakage Current

#### **PRODUCT BENEFITS**

- Low Losses
- · Low Noise Switching
- Cooler Operation
- · Higher Reliability Systems
- Increased System Power Density





- 1 Cathode
- 2 Anode Back of Case - Cathode

#### **MAXIMUM RATINGS**

All Ratings:  $T_C = 25^{\circ}C$  unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT60D120B(G)_S(G)	UNIT
V <sub>R</sub>	Maximum D.C. Reverse Voltage		
V <sub>RRM</sub>	Maximum Peak Repetitive Reverse Voltage	1200	Volts
V <sub>RWM</sub>	Maximum Working Peak Reverse Voltage		
I <sub>F(AV)</sub>	Maximum Average Forward Current (T <sub>C</sub> = 126°C, Duty Cycle = 0.5)	60	
I <sub>F(RMS)</sub>	RMS Forward Current (Square wave, 50% duty)	115	Amps
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current (T <sub>J</sub> = 45°C, 8.3ms)	540	
T <sub>J</sub> ,T <sub>STG</sub>	Operating and StorageTemperature Range	-55 to 175	°C
T <sub>L</sub>	Lead Temperature for 10 Sec.	300	9

#### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		MIN	TYP	MAX	UNIT
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 60A		2.0	2.5	Volts
		I <sub>F</sub> = 120A		2.3		
		I <sub>F</sub> = 60A, T <sub>J</sub> = 125°C		1.8		
I <sub>RM</sub>	Maximum Reverse Leakage Current	V <sub>R</sub> = V <sub>R</sub> Rated			250	μA
		$V_R = V_R$ Rated, $T_J = 125$ °C			500	
C <sub>T</sub>	Junction Capacitance, V <sub>R</sub> = 200V			60		pF

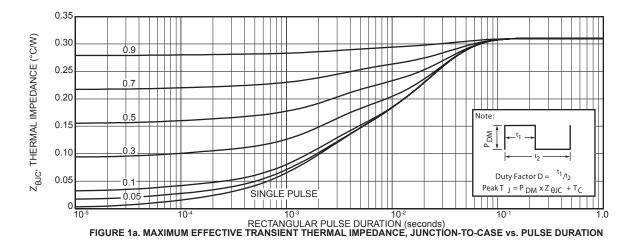
## **DYNAMIC CHARACTERISTICS**

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
t <sub>rr</sub>	Reverse Recovery Time $I_F = 1A$ , $di_F/dt =$	overy Time $I_F = 1A$ , $di_F/dt = -100A/\mu s$ , $V_R = 30V$ , $T_J = 25^{\circ}C$		38		ns
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 60A$ , $di_F/dt = -200A/\mu s$ $V_R = 800V$ , $T_C = 25^{\circ}C$	-	400		115
Q <sub>rr</sub>	Reverse Recovery Charge		-	1200		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	6	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 60A$ , $di_F/dt = -200A/\mu s$ $V_R = 800V$ , $T_C = 125^{\circ}C$	-	470		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	4000		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	13	-	Amps
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 60A$ , $di_F/dt = -1000A/\mu s$ $V_R = 800V$ , $T_C = 125°C$	-	200		ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	6200		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current		-	47		Amps

## THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
R <sub>eJC</sub>	Junction-to-Case Thermal Resistance			.31	°C/W
R <sub>θJA</sub>	Junction-to-Ambient Thermal Resistance			40	
W <sub>T</sub>	Package Weight		0.22		OZ
			5.9		g
Torque	Maximum Mounting Torque			10	lb•in
				1.1	N•m

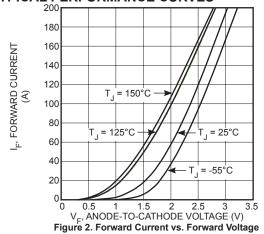
Microsemi reserves the right to change, without notice, the specifications and information contained herein.



Power (watts) 0.0225 °C/W 0.00436 J/ °C 0.123 °C/W 0.0115 J/ °C 0.165 °C/W 0.117 J/ °C

FIGURE 1b, TRANSIENT THERMAL IMPEDANCE MODEL

## **TYPICAL PERFORMANCE CURVES**



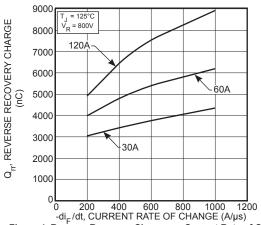
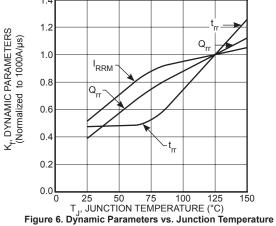
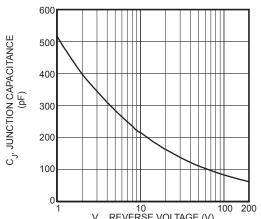


Figure 4. Reverse Recovery Charge vs. Current Rate of Change





V<sub>R</sub>, REVERSE VOLTAGE (V)
Figure 8. Junction Capacitance vs. Reverse Voltage

# APT60D120B(G)\_S(G)

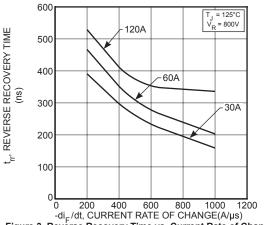


Figure 3. Reverse Recovery Time vs. Current Rate of Change

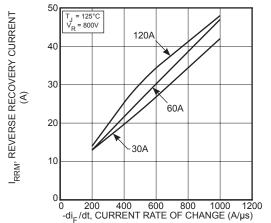


Figure 5. Reverse Recovery Current vs. Current Rate of Change

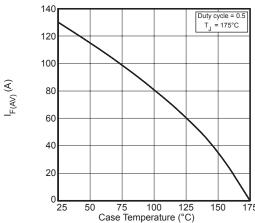


Figure 7. Maximum Average Forward Current vs. CaseTemperature

Figure 9. Diode Test Circuit

- 1 I<sub>E</sub> Forward Conduction Current
- 2 di<sub>E</sub>/dt Rate of Diode Current Change Through Zero Crossing.
- 3 I<sub>RRM</sub> Maximum Reverse Recovery Current
- t<sub>rr</sub> Reverse Recovery Time measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through I<sub>RRM</sub> and 0.25, I<sub>RRM</sub> passes through zero.
- $\mathbf{5}$   $\mathbf{Q}_{\mathrm{rr}}$  Area Under the Curve Defined by  $\mathbf{I}_{\mathrm{RRM}}$  and  $\mathbf{t}_{\mathrm{RR}}$

Zero

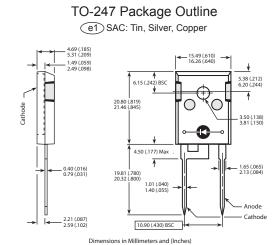
Zero

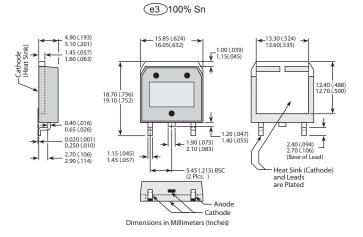
O.25 I<sub>RRM</sub>

ere

ugh zero.

Figure 10. Diode Reverse Recovery Waveform Definition





D<sup>3</sup> PAK Outline

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